

Multilayer Ceramic Chip Capacitors

CGA6M1C0G3A332J200AE



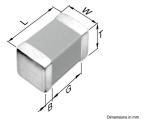






TDK item description CGA6M1C0G3A332JT***S

Applications	Automotive Grade	
	High High Voltage (1000V and over)	
Feature	Soft Termination	
	AEC-Q200 AEC-Q200	
Series	CGA6(3225) [EIA 1210]	
Status	Production	



	Size	
Length(L)	3.20mm +0.50,-0.40mm	
Width(W)	2.50mm ±0.30mm	
Thickness(T)	2.00mm +0.30,-0.20mm	
Terminal Width(B)	0.20mm Min.	
Terminal Spacing(G)		
Recommended Land Pattern (PA)	2.00mm to 2.40mm	
Recommended Land Pattern (PB)	1.00mm to 1.20mm	
Recommended Land Pattern (PC)	1.90mm to 2.50mm	
Recommended Slit Pattern (SD)		

Electrical Characteristics		
Capacitance	3.3nF ±5%	
Rated Voltage	1kVDC	
Temperature Characteristic	C0G(0±30ppm/°C)	
Q (Min.)	1000	
Insulation Resistance (Min.)	10000ΜΩ	

Other	
Soldering Method	Reflow
AEC-Q200	Yes
Packing	Blister (Plastic)Taping [180mm Reel]
Package Quantity	1000pcs

[!] Images are for reference only and show exemplary products. ! This PDF document was created based on the data listed on the TDK Corporation website.

[!] All specifications are subject to change without notice.

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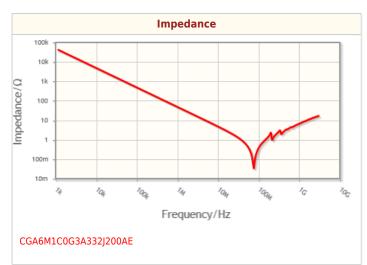




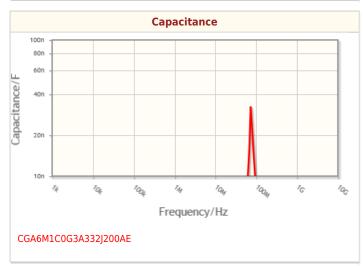


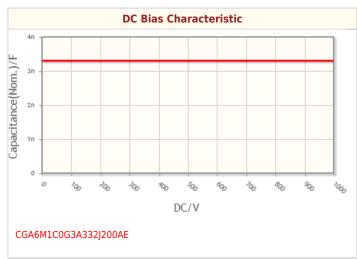


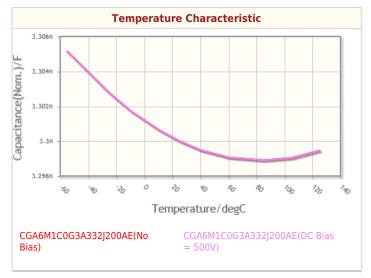
Characteristic Graphs(This is reference data, and does not guarantee the products characteristics.)











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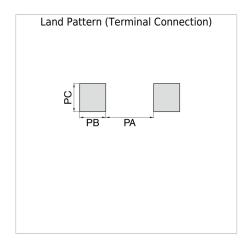








Associated Images



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